

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Forward Voltage @ I <sub>F</sub> = 10mA	V <sub>F</sub>	0.9	V

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P <sub>D</sub>	200	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	R <sub>θJA</sub>	625	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Type Number	Marking Code	Zener Voltage Range (Note 6)				Maximum Zener Impedance (Note 7)			Maximum Reverse Current (Note 6)		Temperature Coefficient of Zener Voltage @ I <sub>ZT</sub> = 5mA mV/°C	
		V <sub>Z</sub> @ I <sub>ZT</sub>			I <sub>ZT</sub>	Z <sub>ZT</sub> @ I <sub>ZT</sub>	Z <sub>ZK</sub> @ I <sub>ZK</sub>	I <sub>ZK</sub>	I <sub>R</sub>	V <sub>R</sub>		
		Nom (V)	Min (V)	Max (V)	mA	Ω		mA	μA	@V	Min	Max
BZX84C2V4TS	KRB	2.4	2.2	2.6	5	100	600	0.5	50	1.0	-3.5	0
BZX84C2V7TS	KRC	2.7	2.5	2.9	5	100	600	1.0	20	1.0	-3.5	0
BZX84C3V0TS	KRD	3.0	2.8	3.2	5	95	600	1.0	10	1.0	-3.5	0
BZX84C3V3TS	KRE	3.3	3.1	3.5	5	95	600	1.0	5.0	1.0	-3.5	0
BZX84C3V6TS	KRF	3.6	3.4	3.8	5	90	600	1.0	5.0	1.0	-3.5	0
BZX84C3V9TS	KRG	3.9	3.7	4.1	5	90	600	1.0	3.0	1.0	-3.5	0
BZX84C4V3TS	KRH	4.3	4.0	4.6	5	90	600	1.0	3.0	1.0	-3.5	0
BZX84C4V7TS	KR1	4.7	4.4	5.0	5	80	500	1.0	3.0	2.0	-3.5	0.2
BZX84C5V1TS	KR2	5.1	4.8	5.4	5	60	480	1.0	2.0	2.0	-2.7	1.2
BZX84C5V6TS	KR3	5.6	5.2	6.0	5	40	400	1.0	1.0	2.0	-2.0	2.5
BZX84C6V2TS	KR4	6.2	5.8	6.6	5	10	150	1.0	3.0	4.0	0.4	3.7
BZX84C6V8TS	KR5	6.8	6.4	7.2	5	15	80	1.0	2.0	4.0	1.2	4.5
BZX84C8V2TS	KR7	8.2	7.7	8.7	5	15	80	1.0	0.7	5.0	3.2	6.2
BZX84C10TS	KR9	10.0	9.4	10.6	5	20	150	1.0	0.2	7.0	4.5	8.0
BZX84C11TS	KP1	11.0	10.4	11.6	5	20	150	1.0	0.1	8.0	5.4	9.0
BZX84C12TS (Note 8)	KP2	12.0	11.4	12.7	5	25	150	1.0	0.1	8.0	6.0	10.0
BZX84C13TS	KP3	13.0	12.4	14.1	5	30	170	1.0	0.1	8.0	7.0	11.0
BZX84C15TS	KP4	15.0	13.8	15.6	5	30	200	1.0	0.1	10.5	9.2	13.0
BZX84C16TS	KP5	16.0	15.3	17.1	5	40	200	1.0	0.1	11.2	10.4	14.0
BZX84C18TS	KP6	18.0	16.8	19.1	5	45	225	1.0	0.1	12.6	12.4	16.0
BZX84C20TS	KP7	20.0	18.8	21.2	5	55	225	1.0	0.1	14.0	14.4	18.0
BZX84C24TS	KP9	24.0	22.8	25.6	5	70	250	1.0	0.1	16.8	18.4	-
BZX84C27TS	KPA	27.0	25.1	28.9	2	80	300	0.5	0.1	18.9	21.4	-
BZX84C39TS	KPE	39.0	37.0	41.0	2	130	350	0.5	0.1	27.3	33.4	-

- Notes:
5. Mounted on FR-4 PC Board with recommended pad layout which can be found on our website at <http://www.diodes.com/package-outlines.html>.
  6. Short duration pulse test used to minimize self-heating effect.
  7. f = 1kHz.
  8. Qualified to AEC-Q101 standards for high reliability.

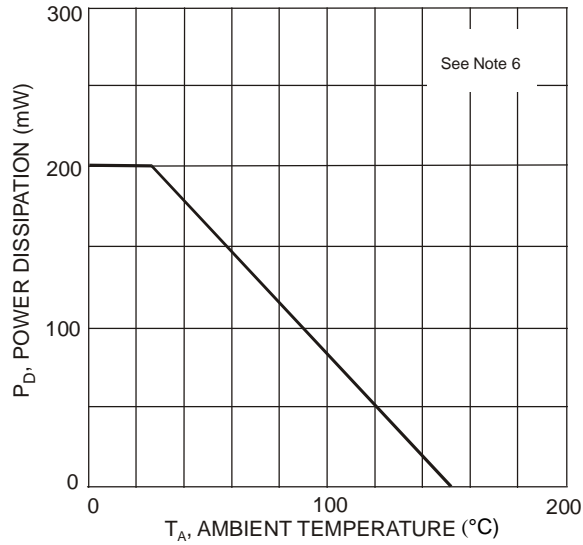


Fig. 1. Power Derating Curve

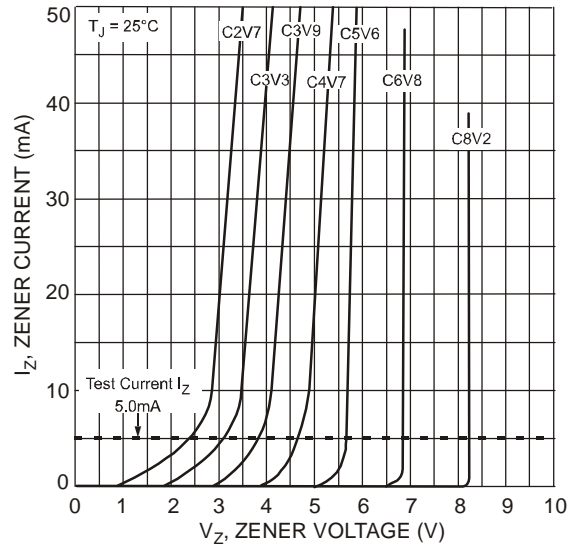


Fig. 2. Typical Zener Breakdown Characteristics

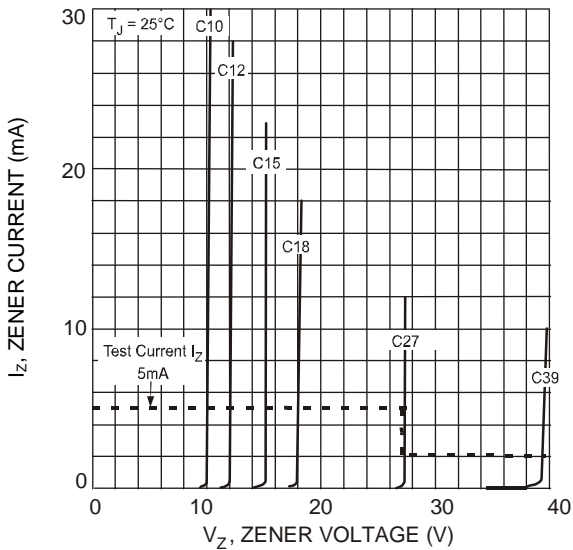


Fig. 3. Typical Zener Breakdown Characteristics

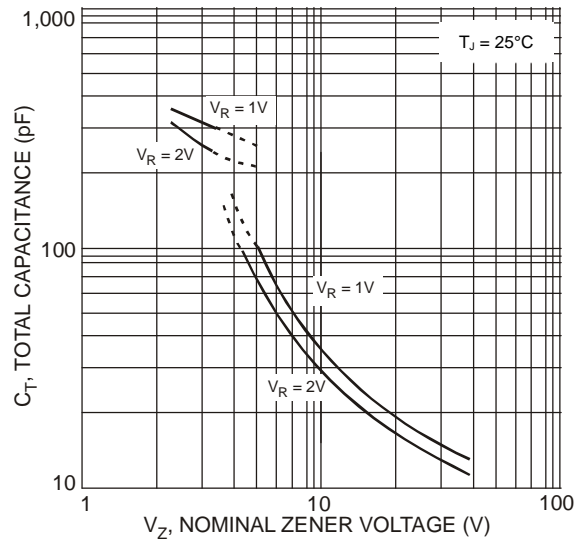
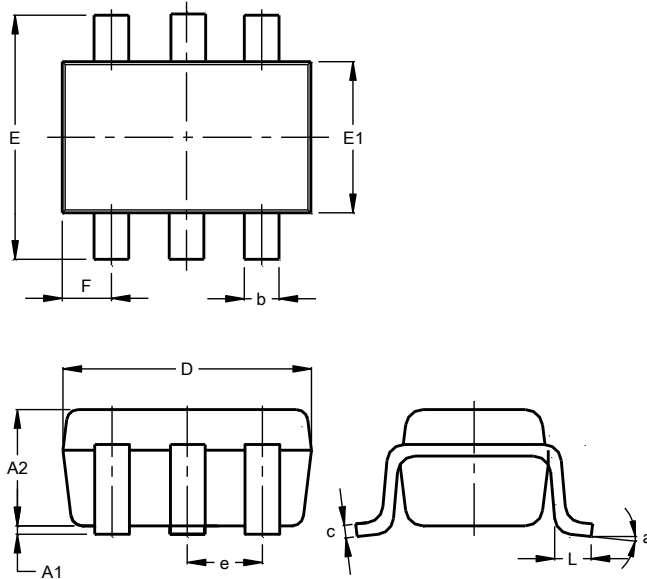


Fig. 4. Typical Total Capacitance vs. Nominal Zener Voltage

## Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### SOT363

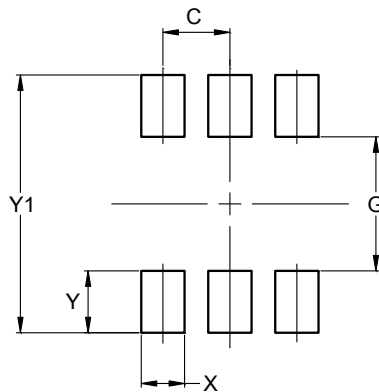


SOT363			
Dim	Min	Max	Typ
A1	0.00	0.10	0.05
A2	0.90	1.00	0.95
b	0.10	0.30	0.25
c	0.10	0.22	0.11
D	1.80	2.20	2.15
E	2.00	2.20	2.10
E1	1.15	1.35	1.30
e	0.650 BSC		
F	0.40	0.45	0.425
L	0.25	0.40	0.30
a	0°	8°	--
All Dimensions in mm			

## Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

### SOT363



Dimensions	Value (in mm)
C	0.650
G	1.300
X	0.420
Y	0.600
Y1	2.500

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